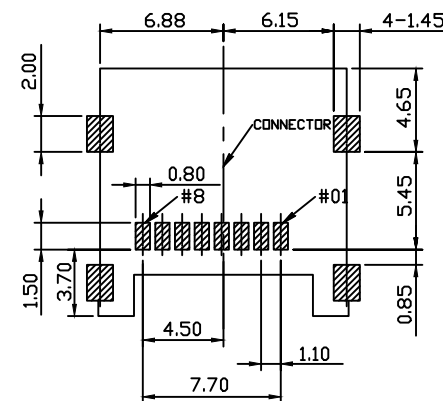
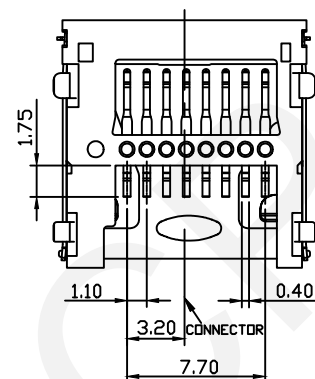
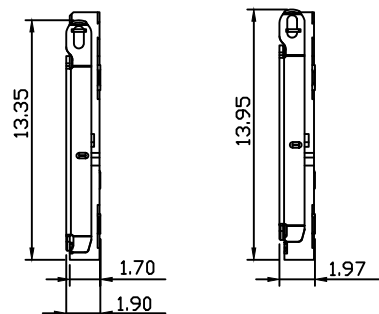
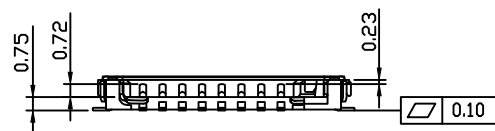


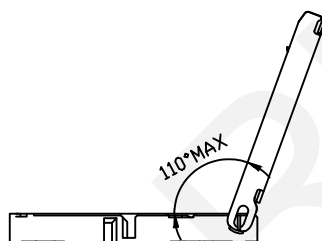
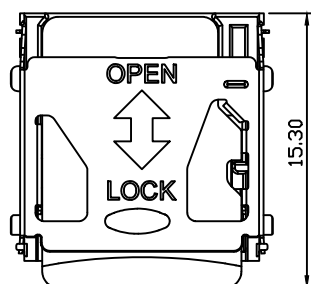
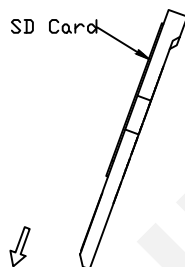
SLIDE SHELL LOLK SLIDE SHELL OPEN



RECOMMENDED PCB LAYOUT

TOLERANCE ± 0.05  SOLDER AREA

Micro SD Card



Pin NO	NAME
#01	DAT2
#02	CD/DAT3
#03	CMD
#04	VDD
#05	CLK
#06	VSS
#07	DAT0
#08	DAT1

Materials:

Insulator: High Temperature Thermoplastic

Flammability Rating,UL94V-0,Black.

Contact: Copper Alloys

Cover: Stainless Steel

Contact Area Plating: Gold Voer Ni

Solder Tail Coplanarity Must Be Within .005" (0.127mm)



RHTECP NINGBO RHT ELECTRONIC CO.,LTD

UNITS:mm

SHEET SIZE: A4

SCALE:---

DRWN BY PAN

Micro SD Card CONN:HINGED TYPE,H1.9mm

0~3

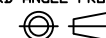
3~18

18~50

50~120

CHK'D BY FENG

THIRD ANGLE PROJECTION



RHTAYF-017-H1.9-R

1

2

3

4

5

6

7

8

9